

RoHS

COMPLIANT

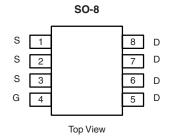
HALOGEN

FREE Available

Vishay Siliconix

N-Channel Reduced Q_g, Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V) R _{DS(on)} (Ω)		I _D (A)			
30	0.0085 at V _{GS} = 10 V	15			
	0.0125 at V _{GS} = 4.5 V	12			



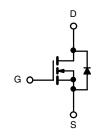
Ordering Information: Si4384DY-T1-E3 (Lead (Pb)-free) Si4384DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Gen II Power MOSFETs
- PWM Optimized
- 100 % R_g Tested

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Desktop
 - Server



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	± 20		v	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	– I _D	15	10		
	T _A = 70 °C		12	8		
Pulsed Drain Current		I _{DM}	± 50		А	
Continuous Source Current (Diode Conduction) ^a		۱ _S	2.8	1.3		
Single Pulse Avalanche Current		I _{AS}	25			
Avalanche Energy	L = 0.1 mH	E _{AS}	31		mJ	
	T _A = 25 °C	- P _D	3.1	1.47	w	
Maximum Power Dissipation ^a	T _A = 70 °C		2	0.95		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55	to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Mauinum lunction to Ambient (MOOFET)	t ≤ 10 s	- R _{thJA}	34	40	°C/W	
Maximum Junction-to-Ambient (MOSFET) ^a	Steady State		71	85		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	20		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	IDSS	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 70 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40			А	
Drain-Source On-State Resistance ^a	Б			0.007	0.0085	Ω	
	R _{DS(on)}			0.0105	0.0125		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		56		S	
Diode Forward Voltage ^a	V _{SD}	$I_{S} = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic ^b							
Total Gate Charge	Qg			12	18		
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 15 A		5.9		nC	
Gate-Drain Charge	Q _{gd}			4.0			
Gate Resistance	Rg		0.8	1.7	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		13	20		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong\text{1}$ A, V_GEN = 10 V, R_g = 6 Ω		45	70	ns	
Fall Time	t _f			13	20		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.8 A, dl/dt = 100 A/μs		25	50		

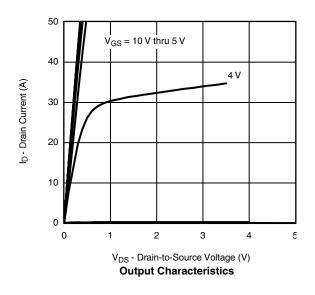
Notes:

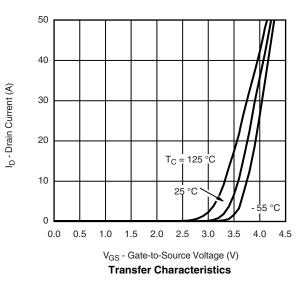
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

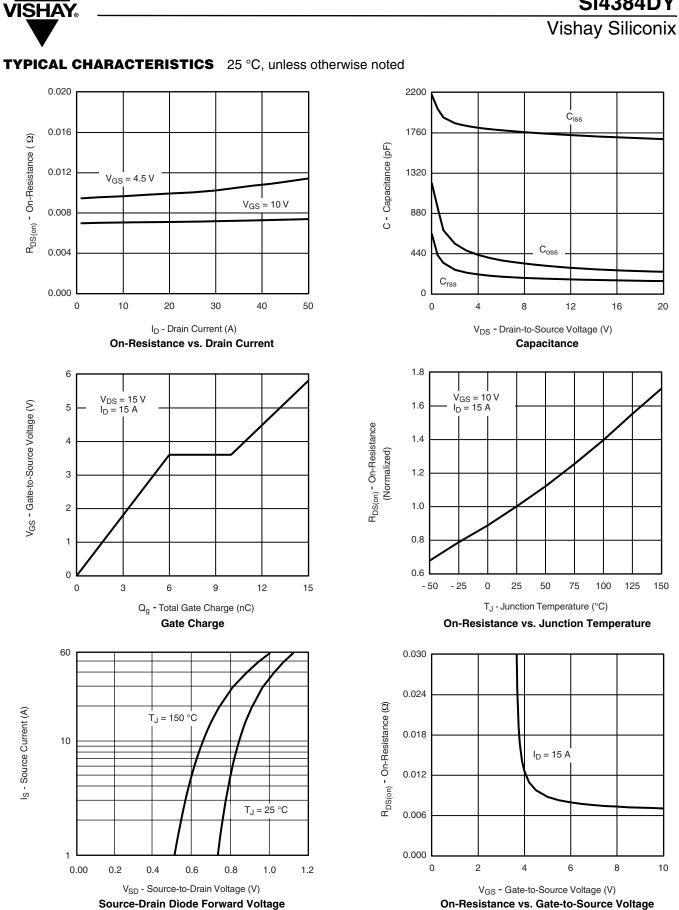
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







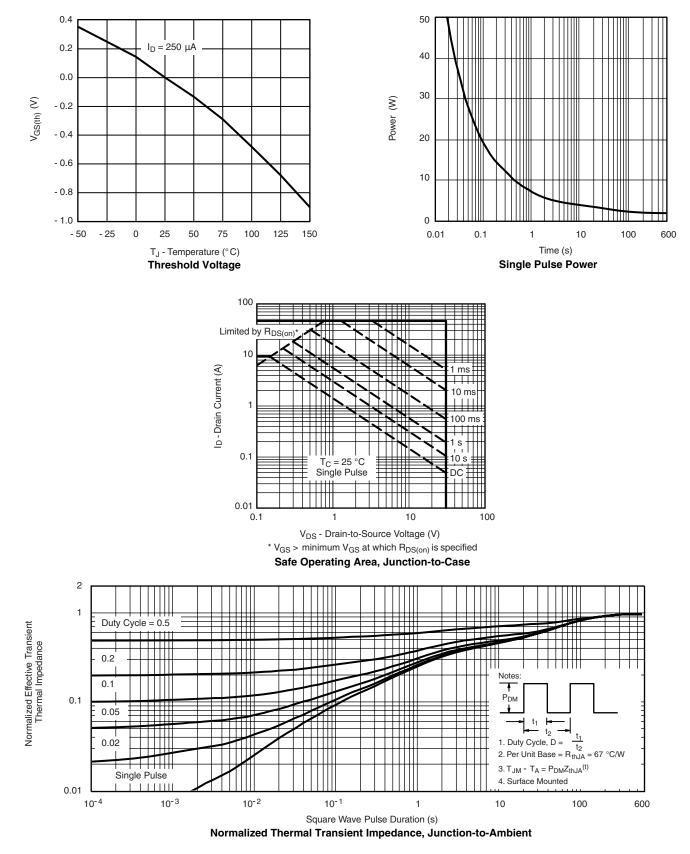
Si4384DY

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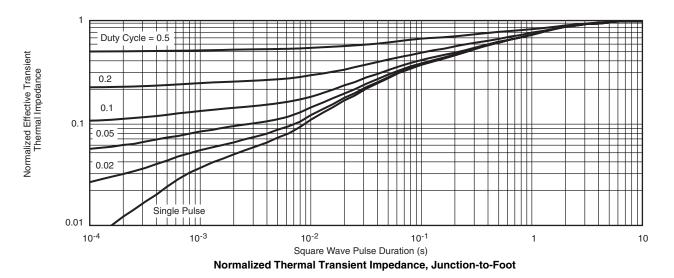
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Si4384DY Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?72645</u>.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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